

East Search for  
Paper no. 12

L Number	Hits	Search Text	DB	Time stamp
-	88	overlay adj target	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:47
-	0	77044203.URPN.	USPAT	2002/02/14 17:51
-	12	"5877761" "5776645"	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:49
-	10119	alignment adj mark	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:49
-	4777	((alignment adj mark) and substrate	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:50
-	198	((alignment adj mark) and residue	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:50
-	5	((alignment adj mark) and residue) and residue with (improve increase registration register)	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:51
-	3	((alignment adj mark) and residue) and residue with (lower decrease)	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:56
-	1	((alignment adj mark) and residue) and residue with (improve increase registration register)) and (((alignment adj mark) and residue) and residue with (lower decrease))	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:56
-	7	((alignment adj mark) and residue) and residue with (improve increase registration register)) (((alignment adj mark) and residue) and residue with (lower decrease))	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:56
-	7	((alignment adj mark) and residue) and residue with (improve increase registration register)) alignment adj mark and residue and residue with (lower decrease)	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:56
-	1964	((257/797) or (438/401,462,975)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:56
-	458	((257/797) or (438/401,462,975)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2002/02/14 17:56

USPAT;  
US-PGPUB;  
EPO; JPO;  
DEFWENT;  
IBM\_TDB

3	5982044.URPN.	USPAT	2002/02/14 18:13
13	("3793044"   "5129283"   "5316966"   "5356513"   "5578519"   "5627110"   "5877562"   "5889335"   "5893744"   "5911109"   "5946583"   "5950093"   "5982044").PN.	USPAT	2002/02/14 18:23
10	6145133.URPN.	USPAT	2002/02/14 18:23
7	("3600241"   "3802940"   "4134066"   "4233091"   "4356223"   "4640988"   "4642672").PN.	USPAT	2002/02/14 18:23
17	5128293.URPN.	USPAT	2002/02/14 18:23
151	((((257/797) or (438/401,462,975)).CCLS.) and resist) and patterning	USPAT; US-PGPUB; EPC; JPO; DERWENT; IBM_TDB	2002/02/14 18:43
119	((((257/797) or (438/401,462,975)).CCLS.) and resist) and patterning) and etching	USPAT; US-PGPUB; EPC; JPO; DERWENT; IBM_TDB	2002/02/14 18:51
60	(((((257/797) or (438/401,462,975)).CCLS.) and resist) and patterning) and etching) and etching with substrate	USPAT; US-PGPUB; EPC; JPO; DERWENT; IBM_TDB	2002/02/15 09:11
12	("4981529"   "5198390"   "5234068"   "5314843"   "5401691"   "5523254"   "5556808"   "5622899"   "5668042"   "5700732"   "5786260"   "5801090").PN.	USPAT	2002/02/14 19:26
6	5923996.URPN.	USPAT	2002/02/14 19:26
62	("5129283" "5468664" "5523254" "5923996" "5958900" "6025652" "6271602" "6309944" "6316328" "5712717" "6130750" "5776645" "5124927" "5731877" "5805290" "6128089" "6309944" "6043133" "4590382" "5365072" "5982044" "6313517" "6008070" "5700732" "6261913" "6172409");[pn]	USPAT; US-PGPUB; EPC; JPO; DERWENT; IBM_TDB	2002/02/15 09:16
25	(US-6323527-\$ or US-6316328-\$ or US-6309944-\$ or US-6271602-\$ or US-6261918-\$ or US-6172409-\$ or US-6130750-\$ or US-6128089-\$ or US-6043133-\$ or US-6025652-\$ or US-6008070-\$ or US-5982044-\$ or US-5958900-\$ or US-5923996-\$ or US-5805290-\$ or US-5776645-\$ or US-5731877-\$ or US-5712707-\$ or US-5700732-\$ or US-5523254-\$ or US-5468664-\$ or US-5365072-\$ or US-5129283-\$ or US-5124927-\$ or US-4590382-\$).did.	USPAT	2002/02/15 19:17
1964	((257/797) or (438/401,462,975)).CCLS.	USPAT; US-PGPUB; EPC; JPO; DERWENT; IBM_TDB	2002/02/15 19:34

51	((257/797) or (438/401,462,975)).CCLS.) and (method mark).tl.) and etching with substrate) same resist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 10:36
111	((257/797) or (438/401,462,975)).CCLS.) and (method and mark).tl.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 10:36
42	((257/797) or (438/401,462,975)).CCLS.) and (method and mark).tl.) and etching with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 10:36
2	jp-62018714-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 11:00
1	1985JP-0158781.ap,pral.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 11:01
9	deguchi and alignment adj mark	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 11:02
4	jp-62018714-\$.did. jp-63187628-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/15 13:13
0	63187628.URPN.	USPAT	2002/02/15 13:14
0	63187628.URPN.	USPAT	2002/02/15 13:14
1	1988-259909.NPAN.	DERWENT	2002/02/15 13:14
1	1987-062200.NPAN.	DERWENT	2002/02/15 13:14
0	62018714.URPN.	USPAT	2002/02/15 13:14